

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
ZHIYONG DAI	08/27/2018
LVHAI HU	08/27/2018
YINGCONG DENG	08/30/2018
YUN LIU	08/27/2018
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State/Country:	CHINA
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Internal Address:	XIANGZHOU DISTRICT, GUANGDONG
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State/Country:	CHINA
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16141030
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NAME OF SUBMITTER:	SALVATORE ANASTASI
SIGNATURE:	/Salvatore Anastasi/
DATE SIGNED:	09/25/2018
Total Attachments: 2 source=DeclAsn#page1.tif source=DeclAsn#page2.tif	

11-September-2018

Our Ref.: P186028.US.01

Client Ref.: TY-00523 US

Attorney Docket No.: 21334-2699

COMBINED DECLARATION AND ASSIGNMENT

As a below-named inventor, I hereby declare that:

this declaration is directed to inventions and improvements disclosed in:

☒ the attached application, or☐ United States application or PCT international application number _____ filed on _____, entitled Robot Assembling System And Method For Assembling Multi-Layer Cage ("the APPLICATION")

The APPLICATION was made or authorized to be made by me;

I believe that I am the original inventor or an original joint inventor of a claimed invention in the APPLICATION;

I have reviewed and understand the contents of the APPLICATION, including the claims, and I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37.C.F.R 1.56; AND

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

As a below named and signing inventor, acknowledging that I have assigned or have obligations to assign the APPLICATION to:

TYCO ELECTRONICS (SHANGHAI) CO. LTD. AND INNOGETIC TECHNOLOGY CO., LTD ("ASSIGNEE"), corporations organized and existing under and by virtue of the laws of China having their principal place of business at Sections F and G, Level 1, Building 15 No. 999 Yinglun Road China (Shanghai) Pilot Free Trade Zone Shanghai, CN and 3/F, Bldg 2, No.10, Futian Road Xiangzhou District Zhuhai City, Guangdong, CN,

for a valuable consideration, the receipt of which is hereby acknowledged, I do hereby sell, assign, transfer and set over unto the said ASSIGNEE, its successors and assigns, my full and entire right, title and interest in and to the APPLICATION, the inventions and improvements disclosed in the APPLICATION, all divisions, continuations, continuations-in-part, or renewals thereof, all Letters Patent to be granted and issued therefor, not only for, to and in the rights under the International Convention, and all reissues, re-examinations, renewals or extensions thereof, and I hereby authorize and request the United States Patent and Trademark Office and/or other patent office(s) to issue said Letters Patent to said ASSIGNEE, its successors and assigns, in accordance with this assignment

Legal Name	Signature	Date
DAI, Zhiyong	代智勇	2018-8-27
HU, Lvhai	胡子海	2018.8.27
DENG, Yingcong	邓颖聪	2018.8.30
LIU, Yun	刘云	2018.8.27

WONG, Kok Wai		
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